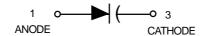


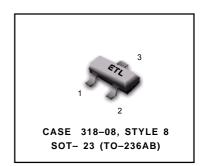
Silicon Tuning Diode

This device is designed for 900 MHz frequency control and tuning applications. It provides solid–state reliability in replacement of mechanical tuning methods.

- Controlled and Uniform Tuning Ratio
- Available in Surface Mount Package
- Available in 8 mm Tape and Reel



MMBV809LT1



MAXIMUM RATINGS(EACH DIODE)

Rating	Symbol	Value	Unit			
Reverse Voltage	V _R	20	Vdc			
Forward Current	l _F	20	mAdc			
Device Dissipation ⁽¹⁾ @T _A = 25°C	P _D	225	mW			
Derate above 25°C		1.8	mW/°C			
Junction Temperature	ТJ	+125	°C			
Storage Temperature Range	T stg	-55 to +150	°C			

DEVICE MARKING

MMBV809LT1=5K

ELECTRICAL CHARACTERISTICS(T_A=25°C unless otherwise noted)

		,			
Characteristic	Symbol	Min	Max	Unit	
Reverse Breakdown Voltage	V	20		Vdc	
(I _R =10μAdc)	V _{(BR)R}	20	_	vuc	
Reverse Voltage Leakage Current	ı		50	nAdc	
(V _R =15Vdc)	I _R	_	30	HAUC	

Device Type	C _T Diode Capacitance V _R =2.0Vdc,f=1.0MHz pF		Q,Figure of Merit V _R =3.0Vdc f=500MHz		C _R ,Capacitance Ratio C ₂ /C ₈ f=1.0MHz(2)			
	Min	Тур	Max	Тур		Mii	n	Max
MMBV809LT1	4.5	5.3	6.1	75		1.8	3	2.6

- 1. FR-5 Board 1.0 x 0.75 x 0.62 in.
- 2. C_R is the ratio of C_t measured at 2.0 Vdc divided by C_t measured at 8.0 vdc



MMBV809LT1

TYPICAL CHARACTERISTICS

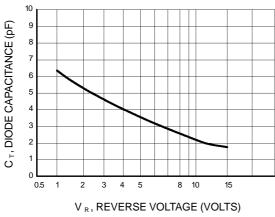


Figure 1. Diode Capacitance

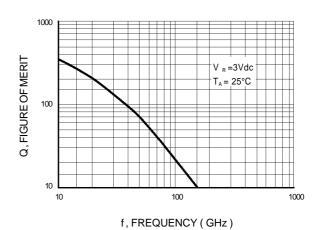


Figure 2. Figure of Merit

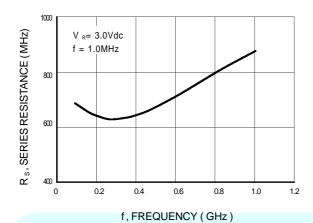
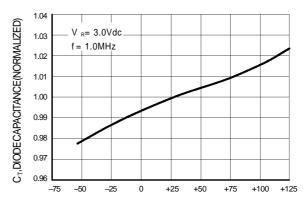


Figure 3. Series Resistance



T_A, AMBIENT TEMPERATURE (°C)

Figure 4. Diode Capacitance

SEMICONDUCTOR